<span id="page-0-0"></span>



## **Triple, Ultra-Wideband, Current-Feedback OPERATIONAL AMPLIFIER with Disable**

- **2**•
- 
- •**WIDE OUTPUT VOLTAGE SWING: ±4V**
- •**ULTRA-HIGH SLEW RATE: 4300V/**µ**<sup>s</sup>**
- •**3RD-ORDER INTERCEPT:**  $> 35$ **dBm (f < 40MHz)**
- •**LOW 1.8nV/√Hz VOLTAGE NOISE**
- **±120mA OUTPUT CURRENT DRIVE**
- •
- •**LOW 0.1mA/Ch DISABLE CURRENT**
- •**3.5V to 12V SINGLE-SUPPLY OPERATION**
- •

### **APPLICATIONS**

- •
- •
- •
- **HIGH-SPEED IMAGING**
- •**ACTIVE FILTERS**
- •



### **Figure 1. Typical RGB Input/Output Buffer Application**

### **<sup>1</sup>FEATURES DESCRIPTION**

 **900MHz BANDWIDTH, GAIN <sup>=</sup> +2V/V** The OPA3695 is <sup>a</sup> triple, very high bandwidth, **450MHz BANDWIDTH, GAIN <sup>=</sup> +8V/V** current-feedback op amp that combines an exceptional 4300V/µ<sup>s</sup> slew rate and <sup>a</sup> very high 900MHz bandwidth  $(G = +2V/V)$  to provide an amplifier that is ideal for the most demanding video applications. The device versatility is enhanced with a low 1.8nV/√Hz input voltage noise and an output stage that can swing within 1V from the supply rail to deliver <sup>a</sup> high dynamic range signal, making it **12.9mA/Ch SUPPLY CURRENT (±5V)** well-suited for analog-to-digital converter (ADC) front-ends or digital-to-analog converter (DAC) output buffering. Optimized for high gain operation, the OPA3695 is also well-suited for buffering surface **±1.75V to ±6V SPLIT-SUPPLY OPERATION** acoustic wave (SAW) filters in an intermediate frequency (IF) system.

The low 12.9mA/channel supply current is precisely **BROADBAND VIDEO LINE DRIVERS** trimmed at +25°C. This trim, along with a low<br>**VERY WIDEBAND ADC DRIVERS** temperature drift gives low system power over temperature drift, gives low system power over **HIGH BANDWIDTH INSTRUMENTATION** temperature. System power may be further reduced **AMPLIFIERS EXECUTERS EXECUTE:**  $\frac{1}{2}$  using the Disable control pin. Leaving this pin open, or holding it high, gives normal operation. If pulled low, the OPA3695 supply current drops to 100µA/channel. This power-saving feature, along with **ARB WAVEFORM OUTPUT DRIVERS** exceptional single +5V operation, makes the OPA3695 <sup>a</sup> good fit for low-power applications that require very high performance. The OPA3695 is available in an SSOP-16 package.

### **OPA3695 RELATED PRODUCTS**



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### <span id="page-1-0"></span>**[OPA3695](http://focus.ti.com/docs/prod/folders/print/opa3695.html)**



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### **ORDERING INFORMATION(1)**



(1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

### **ABSOLUTE MAXIMUM RATINGS(1)**

Over operating free-air temperature range (unless otherwise noted).



(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these and any other conditions beyond those specified is not supported.

### **PARAMETER INFORMATION**



<span id="page-2-0"></span>

**[OPA3695](http://focus.ti.com/docs/prod/folders/print/opa3695.html)**

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### **ELECTRICAL CHARACTERISTICS:**  $V_s = \pm 5V$

**Boldface** limits are tested at **+25°C.**

At  $R_F = 402Ω$ ,  $R_L = 100Ω$ , and  $G = +8$ , unless otherwise noted.



(1) Test levels: (A) 100% tested at +25°C. Over temperature limits set by characterization and simulation. (B) Limits set by characterization and simulation. (C) Typical value only for information.

(2) Junction temperature = ambient for  $+25^{\circ}$ C specifications.

 $(3)$  Junction temperature = ambient at low temperature limits; junction temperature = ambient +48°C at high temperature limit for over temperature specifications.

(4) Current is considered positive out of pin.

(5) Tested <sup>&</sup>lt; 3dB below minimum specified CMRR at ±CMIR limits.

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### **ELECTRICAL CHARACTERISTICS:**  $V_s = \pm 5V$  (continued)

**Boldface** limits are tested at **+25°C.**

At  $R_F = 402Ω$ ,  $R_L = 100Ω$ , and  $G = +8$ , unless otherwise noted.





### **ELECTRICAL CHARACTERISTICS:**  $V_s = +5V$

### **Boldface** limits are tested at **+25°C.**

At  $R_F = 348\Omega$ ,  $R_L = 100\Omega$  to 2.5V, and G = +8, unless otherwise noted.



(1) Test levels: (A) 100% tested at +25°C. Over temperature limits set by characterization and simulation. (B) Limits set by characterization and simulation. (C) Typical value only for information.

(2) Junction temperature = ambient for  $+25^{\circ}$ C specifications.

(3) Junction temperature <sup>=</sup> ambient at low temperature limits; junction temperature <sup>=</sup> ambient +21°C at high temperature limit for over temperature specifications.

(4) Current is considered positive out of pin.

(5) Tested <sup>&</sup>lt; 3dB below minimum specified CMRR at ±CMIR limits.

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### **ELECTRICAL CHARACTERISTICS:**  $V_s = +5V$  **(continued)**

**Boldface** limits are tested at **+25°C.**

At  $R_F = 348\Omega$ ,  $R_L = 100\Omega$  to 2.5V, and G = +8, unless otherwise noted.



<span id="page-6-0"></span>

Normalized Gain (dB)

Normalized Gain (dB)

### **TYPICAL CHARACTERISTICS:**  $V_s = \pm 5V$

At  $R_F = 402\Omega$ ,  $R_L = 100\Omega$ , and G = +8, unless otherwise noted.





600 **GAIN OF +8, LARGE-SIGNAL FREQUENCY RESPONSE NONINVERTING SMALL-SIGNAL PULSE RESPONSE**

 $V_S = \pm 5V$ 



**NONINVERTING LARGE-SIGNAL PULSE RESPONSE 10MHz HARMONIC DISTORTION vs LOAD RESISTANCE**







### **TYPICAL CHARACTERISTICS:**  $V_s = \pm 5V$  (continued)

At  $R_F = 402\Omega$ ,  $R_L = 100\Omega$ , and  $G = +8$ , unless otherwise noted.



<span id="page-8-0"></span>

### **TYPICAL CHARACTERISTICS:**  $V_s = \pm 5V$  (continued)

At  $R_F = 402\Omega$ ,  $R_L = 100\Omega$ , and  $G = +8$ , unless otherwise noted.











**10MHz HARMONIC DISTORTION vs INVERTING GAIN TWO-TONE, 3RD-ORDER INTERMODULATION INTERCEPT**







### **TYPICAL CHARACTERISTICS:**  $V_s = \pm 5V$  **(continued)**

At  $R_F = 402\Omega$ ,  $R_L = 100\Omega$ , and  $G = +8$ , unless otherwise noted.









At  $R_F = 348\Omega$ ,  $R_L = 100\Omega$  to 2.5V, and G = +8, unless otherwise noted.



### **TYPICAL CHARACTERISTICS:**  $V_s$  **= +5V (continued)**

<span id="page-11-0"></span>At  $R_F = 348\Omega$ ,  $R_L = 100\Omega$  to 2.5V, and G = +8, unless otherwise noted.



<span id="page-12-0"></span>Texas **INSTRUMENTS** 

### **APPLICATION INFORMATION**

### **WIDEBAND BUFFER OPERATION**

The OPA3695 gives the exceptional ac performance of <sup>a</sup> wideband current-feedback op amp with <sup>a</sup> highly linear output stage. Requiring only 12.9mA/channel supply current, the OPA3695 achieves <sup>a</sup> 900MHz small-signal bandwidth  $(G = +2V/V)$ ; the high slew rate capability of up to 4300V/µ<sup>s</sup> supports <sup>a</sup> 600MHz  $2V_{\text{PP}}$  large signal into a 100Ω load. The low output headroom of 1V from either supply in <sup>a</sup> very high-speed amplifier gives very good single +5V operation. The OPA3695 delivers a  $2V_{\text{PP}}$  swing with greater than 400MHz bandwidth operating on <sup>a</sup> single +5V supply. The primary advantage of <sup>a</sup> current-feedback video buffer (as opposed to <sup>a</sup> slew-enhanced, low-gain, stable voltage-feedback implementation) is <sup>a</sup> higher slew rate with lower quiescent power and output noise.

Figure **Figure 35. DC-Coupled, Noninverting,** 35 shows the dc-coupled, noninverting, dual power-supply circuit configuration used as the basis for the ±5V Electrical [Characteristics](#page-2-0) table and Typical [Characteristics](#page-6-0) curves. For test purposes, the [Figure](#page-13-0)  $36$  illustrates the dc-coupled, inverting input impedance is set to  $50\Omega$  with a resistor to configuration used as the basis of the Inverting input impedance is set to  $50Ω$  with a resistor to ground; the output impedance is set to 50Ω with a  $\overline{a}$  Typical Characteristic curves. Inverting operation series output resistor. Voltage swings reported in the  $\overline{a}$  offers several performance benefits. Since the series output resistor. Voltage swings reported in the specifications are taken directly at the input and common-mode signal across the input stage, the slew output pins while load powers (dBm) are defined at <sup>a</sup> rate for inverting operation is higher and the distortion matched 50 $\Omega$  load. For the circuit of Figure 35, the performance is slightly improved. An additional input total effective amplifier loading is 100Ω || (R<sub>F</sub> + R<sub>G</sub>) . resistor, R<sub>M</sub>, is included in [Figure](#page-13-0) 36 to set the input For example, with a gain of +2V/V with R<sub>F</sub> and R<sub>G</sub> impedance equal to 50Ω. The parallel combination of equal to 604Ω, the equivalent amplifier loading is R<sub>M</sub> and R<sub>G</sub> sets the input impedance. Both the 100Ω || 1208Ω <sup>=</sup> 92.3Ω. The disable control line noninverting and inverting applications of Figure 35 (DIS) is typically left open to ensure normal amplifier and [Figure](#page-13-0) 36 benefit from optimizing the feedback operation. Note that while most of the information resistor  $(R_F)$  value for bandwidth (see the discussion presented in this data sheet was characterized with in the *Gain [Setting](#page-16-0)* section). The typical design 100Ω loading, performance with a standard video sequence is to select the R<sub>F</sub> value for best<br>loading of 150Ω has negligible impact on bandwidth, set R<sub>G</sub> for the gain, and then set R<sub>M</sub> for loading of 150 $Ω$  has negligible impact on performance. Any changes in performance are typically improved over 100Ω loading because of for the inverting configuration, a point is reached lower output current demands. where R<sub>G</sub> equals 50Ω and R<sub>M</sub> is removed; thus, the



# **Bipolar-Supply, Specification and Test Circuit**

the desired input impedance. As the gain increases input match is set by  $R_G$  only. With  $R_G$  fixed to achieve an input match to 50Ω, R<sub>F</sub> is simply increased to increase gain. This approach, however, quickly reduces the achievable bandwidth at such high gains. For gains greater than 10V/V, noninverting operation is recommended to maintain broader bandwidth.

![](_page_13_Picture_1.jpeg)

### <span id="page-13-0"></span>SBOS355A–APRIL 2008–REVISED SEPTEMBER 2008 ... **www.ti.com**

![](_page_13_Figure_3.jpeg)

### **Figure 36. DC-Coupled, Inverting, Bipolar-Supply, Specification and Test Circuit**

Notice that in this configuration (shown in Figure 36), the noninverting input is tied directly to ground. Because the internal design for the OPA3695 is current-feedback, trying to achieve improved dc accuracy by including <sup>a</sup> resistor on the noninverting input to ground is ineffective. Using <sup>a</sup> direct short to ground on the noninverting input reduces both the contribution of the dc bias current and the noise current to the output error. While the external  $R_M$  is used here to match with the  $50\Omega$  source from the test equipment, the input impedance in this configuration is limited to the  $R<sub>G</sub>$  resistor. Removing  $R<sub>M</sub>$  does not strongly impact the dc operating point because the short on the noninverting input of Figure 36 provides the dc operating voltage. This application of the OPA3695 provides <sup>a</sup> very broadband, high-output signal inverter.

### **SINGLE-SUPPLY OPERATION**

The OPA3695 may be used over a single-supply range of +3.5V to +12V. Though not a rail-to-rail range of +3.5V to +12V. Though not a rail-to-rail While the circuit of Figure 37 shows +5V<br>The putput design, the OPA3695 requires minimal input single-supply operation this same circuit may be output design, the OPA3695 requires minimal input single-supply operation, this same circuit may be and output voltage headroom compared to other used for single supplies that range as high as +12V and output voltage headroom compared to other used for single supplies that range as high as +12V<br>very-wideband video buffer amplifiers. The key shominal. The noninverting input bias resistors are very-wideband video buffer amplifiers. The key informinal. The noninverting input bias resistors are<br>The requirement of broadband single-supply operation is relatively low in Figure 37 to minimize output do offse requirement of broadband single-supply operation is relatively low in Figure 37 to minimize output dc offset to maintain input and output signal swings within the as a result of noninverting input bias current. At to maintain input and output signal swings within the as a result of noninverting input bias current. At useable voltage ranges at both the input and the higher signal-supply voltages, these resistors should useable voltage ranges at both the input and the bigher signal-supply voltages, these resistors should output.

The circuit of Figure 37 shows the single-supply ac-coupled, gain of +8V/V, video buffer circuit used as the basis for the Electrical [Characteristics](#page-2-0) table and Typical [Characteristics](#page-6-0) curves. The circuit of Figure 37 establishes an input midpoint bias using <sup>a</sup>

simple resistive divider from the +5V supply (two 604Ω resistors). The input signal is then ac-coupled into this midpoint voltage bias. The input voltage can swing to within 1.6V of either supply pin, giving <sup>a</sup>  $1.8V_{PP}$  input signal range centered between the supply pins. The input impedance matching resistor (60.4Ω) used for testing is adjusted to give a  $50Ω$ input match when the parallel combination of the biasing divider network is included. The gain resistor  $(R<sub>G</sub>)$  is ac-coupled, giving the circuit a dc gain of +1V/V, which puts the input dc bias voltage (2.5V) on the output as well. Again, on <sup>a</sup> single +5V supply, the output voltage can swing to within 1V of either supply pin while delivering ±90mA output current. A demanding 100Ω load to <sup>a</sup> midpoint bias is used in this characterization circuit. The new output stage used in the OPA3695 can deliver large bipolar output current into this midpoint load with minimal crossover distortion, as illustrated by the +5V supply, third-harmonic distortion plots.

![](_page_13_Figure_10.jpeg)

**Figure 37. AC-Coupled, G= +8V/V, Single-Supply Specification and Test Circuit**

be increased in order to limit the added supply current drawn through this path.

![](_page_14_Picture_0.jpeg)

![](_page_14_Picture_1.jpeg)

Figure 38 shows the ac-coupled,  $G = +2V/V$ , single-supply specification and test circuit. Once again, the noninverting input is dc-biased at midsupply to put that same  $V_S/2$  at the output pin.

![](_page_14_Figure_4.jpeg)

**Figure 38. AC-Coupled, G= +2V/V, Single-Supply Specification and Test Circuit**

### **HIGH-FREQUENCY ACTIVE FILTERS**

allows an extensive range of active filter topologies to dividely of Figure 39, where the desired 40MHz cutoff is<br>be implemented with minimal amplifier bandwidth achieved and a 40dB/dec roll-off is held through very interaction in the filter shape. While Sallen-Key filters high frequencies. work very well with current-feedback amplifiers, the use of multiple feedback (MFB) filters is not recommended because an MFB filter places <sup>a</sup> capacitor in the feedback path which in turn eliminates compensation and results in an oscillator. In general, given a desired filter  $\omega_{\Omega}$ , the amplifier should have a minimum of 10X  $\omega_{\text{O}}$  to minimize filter interaction with the amplifier frequency response. Figure 39 illustrates an example gain of +2 line driver using the OPA3695 that incorporates <sup>a</sup> 40MHz low-pass Butterworth response with only <sup>a</sup> few external components. The filter resistor values have been adjusted slightly here from an ideal filter analysis to account for parasitic effects.

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![](_page_14_Figure_9.jpeg)

**Figure 39. Line Driver with 40MHz Low-Pass Active Filter**

This type of filter depends on <sup>a</sup> low output impedance from the amplifier through very high frequencies to continue to provide an increasing attenuation with frequency. As the amplifier output impedance rises with frequency, any input signal or noise starts to feed directly through to the output via the feedback capacitor. Because the OPA3695 used in Figure 39 has <sup>a</sup> 900MHz bandwidth, the active filter continues to roll-off through frequencies that exceed 200MHz. The extremely wide bandwidth of the OPA3695 Figure 40 shows the frequency response for the filter allows an extensive range of active filter topologies to of Figure 39, where the desired 40MHz cutoff is achieved and a 40dB/dec roll-off is held through very

![](_page_14_Figure_12.jpeg)

**Figure 40. 40MHz Low-Pass Active Filter Response**

![](_page_15_Picture_2.jpeg)

# **AMPLIFIER**

Figure 41 shows an instrumentation amplifier circuit the three input signals with gains of +2V/V, +4V/V, based on the OPA3695. Because all three amplifiers and +8V/V. The OPA3695 enable and disable times based on the OPA3695. Because all three amplifiers are on the same silicon die, the offset matching between inputs makes this configuration an attractive *make-before-break* disable characteristic of the input stage for this application. The OPA3695 ensures that the output is always under 2V/V. The inputs are high-impedance, with only 1.2pF switch when the signal on the amplifier inputs are to ground at each input. The loads on the OPA3695 very close to each other. outputs are equal for the best harmonic distortion possible.

![](_page_15_Figure_6.jpeg)

**Figure 41. High-Speed Instrumentation Amplifier**

### **HIGH-SPEED INSTRUMENTATION MULTIPLEXED CONVERTER DRIVER**

The converter driver in Figure 42 multiplexes among support multiplexing among video signals. The control. To avoid large switching glitches, it is best to

The voltage difference appearing between the inverting node and the noninverting node should not exceed ±1.2V. This difference can occur when the individual amplifier is disabled and <sup>a</sup> voltage is applied at the summing node of the three amplifiers. The resulting inverting node voltage of the disabled amplifier is easily calculated by using simple resistor voltage divider methods. In general, as the gain of the amplifier increases, the less impact this issue has on the system because of the increased  $R_F/R_G$  ratio.

The output resistors isolate the outputs from each other when switching between channels. The feedback network of the disabled channels forms part of the load seen by the enabled amplifier, attenuating the signal slightly.

![](_page_15_Figure_12.jpeg)

**Figure 42. Multiplexed Converter Driver**

<span id="page-16-0"></span>![](_page_16_Picture_0.jpeg)

### **DEMONSTRATION BOARDS**

A printed circuit board (PCB) is available to assist in the initial evaluation of circuit performance using the OPA3695. The fixture is offered free of charge as an unpopulated PCB, delivered with <sup>a</sup> user's guide. The summary information for this fixture is shown in<br>Table 1.

<b>PRODUCT</b>	<b>PACKAGE</b>	<b>ORDERING</b> <b>NUMBER</b>	<b>LITERATURE</b> <b>NUMBER</b>
OPA3695IDBQ. noninverting	SSOP-16	DEM-OPA-SSOP-3C	SBOU047
OPA3695IDBQ, inverting	SSOP-16	DEM-OPA-SSOP-3D	SBOU046

The demonstration fixture can be requested at the OPA3695 output drive capabilities, noting that the Texas Instruments web site ([www.ti.com](http://www.ti.com)) through the

### **OPERATING SUGGESTIONS**

### **GAIN SETTING**

Similar to other current-feedback amplifiers, the capability, as shown in the Typical [Characteristics](#page-6-0). OPA3695 compensation is dictated by the feedback resistor— $R_F$ . As the resistance increases, more compensation is added to the amplifier. It is important to realize that increasing the resistance too far is not recommended because this increase causes a zero to form on the inverting input as <sup>a</sup> result of stray capacitance. In general,  $R_F$  should not exceed 1.5k $\Omega$ to 2kΩ, or else stability is <sup>a</sup> concern. Table 2 shows the recommended feedback values for common gain settings. These values are <sup>a</sup> good starting point; fine tuning of the resistor value(s) should be done to account for individual PCB designs and other factors.

![](_page_16_Picture_1522.jpeg)

![](_page_16_Picture_1523.jpeg)

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### **DESIGN-IN TOOLS OUTPUT CURRENT AND VOLTAGE**

The OPA3695 provides output voltage and current capabilities that can easily support multiple video loads and/or 100Ω loads with very low distortion. Under no-load conditions at +25°C, the output voltage typically swings to 1V of either supply rail. Into a 15Ω load (the minimum tested load), it is tested to deliver ±120mA.

The specifications described above, though familiar in the industry, consider voltage and current limits **Table 1. Demonstration Fixture** separately. In many applications, it is the voltage x current, or *V-I product*, which is more relevant to **PRODUCT PACKAGE NUMBER NUMBER** circuit operation. Refer to the *Output Voltage and Current Limitations* plot ([Figure](#page-8-0) 18) in the [Typical](#page-6-0) [Characteristics](#page-6-0). The X- and Y-axes of this graph show the zero-voltage output current limit and the zero-current output voltage limit, respectively. The four quadrants give <sup>a</sup> more detailed view of the graph is bounded by <sup>a</sup> *Safe Operating Area* of 1W maximum internal power dissipation. Superimposing resistor load lines onto the plot shows that the OPA3695 can drive ±3.4V into 20Ω or ±3.7V into 50Ω without exceeding either the output capabilities or the 1W dissipation limit. A 100Ω load line (the standard test-circuit load) shows full  $\pm 3.8$ V output swing

> The minimum specified output voltage and current specifications over temperature are set by worst-case simulations at the cold temperature extreme. Only at cold startup do the output current and voltage decrease to the numbers shown in the over-temperature min/max specifications. As the output transistors deliver power, the junction temperatures increase, which decreases the  $V_{BE}$ s (increasing the available output voltage swing) and increases the current gains (increasing the available output current). In steady-state operation, the available output voltage and current are always greater than that shown in the over-temperature characteristics since the output stage junction **±5V OR 10V ±2.5V OR 5V** temperatures are higher than the minimum specified operating ambient.

> To maintain maximum output stage linearity, no output short-circuit protection is provided. This configuration is not normally <sup>a</sup> problem, because most applications include a series matching resistor at the output that limits the internal power dissipation if the output side of this resistor is shorted to ground. However, shorting the output pin directly to an adjacent positive power-supply pin, in most cases, destroys the amplifier. If additional protection to <sup>a</sup> power-supply short is required, consider <sup>a</sup> small series resistor in the power-supply leads. Under heavy output loads, this resistor reduces the available output voltage swing. A  $5Ω$  series resistor in each supply lead, for example, limits the internal power

![](_page_17_Picture_2.jpeg)

dissipation to <sup>&</sup>lt; 1W for an output short while decreasing the available output voltage swing only 0.5V, for up to 100mA desired load currents. Always place the 0.1µF power-supply decoupling capacitors after these supply-current limiting resistors directly on the device supply pins.

### **DRIVING CAPACITIVE LOADS**

One of the most demanding, and yet very common, megligible third-harmonic component. Focusing then load conditions for an op amp is capacitive loading. on the second harmonic, increasing the load Often, the capacitive load is the input of an ADC, impedance improves distortion directly. Remember including additional external capacitance, which may that the total load includes the feedback network—in including additional external capacitance, which may be that the total load includes the feedback network—in<br>be recommended to improve ADC linearity. A be noninverting configuration (see Figure 35), this be recommended to improve ADC linearity. A the noninverting configuration (see [Figure](#page-12-0) 35), this high-speed, high open-loop gain amplifier such as the value is the sum of  $R_F + R_G$ , while in the inverting high-speed, high open-loop gain amplifier such as the value is the sum of  $R_F + R_G$ , while in the inverting OPA3695 can be very susceptible to decreased configuration it is only  $R_F$  (see Figure 36). Also, OPA3695 can be very susceptible to decreased configuration it is only  $R_F$  (see [Figure](#page-13-0) 36). Also,  $R$  stability and may give closed-loop response peaking providing an additional supply decoupling capacitor stability and may give closed-loop response peaking be providing an additional supply decoupling capacitor<br>when a capacitive load is placed directly on the dividing between the supply pins (for bipolar when a capacitive load is placed directly on the (0.01µF) between the supply pins (for bipolar<br>output pin, When the amplifier open-loop output operation) improves the second-order distortion output pin. When the amplifier open-loop output operation) improves resistance is considered, this capacitive load slightly (3dB to 6dB). resistance is considered, this capacitive load introduces an additional pole in the signal path, resulting in <sup>a</sup> feedback path zero that can decrease the phase margin. Several external solutions to this problem have been suggested. When the primary considerations are frequency response flatness, pulse response fidelity, and/or distortion, the simplest and most effective solution is to isolate the capacitive load from the feedback loop by inserting <sup>a</sup> series isolation resistor between the amplifier output and the capacitive load. The isolation acts to reduce the phase lag from the capacitive load pole, thus The intercept is used to predict the intermodulation increasing the phase margin and improving stability. Spurious levels for two closely-spaced frequencies. If

The Typical [Characteristics](#page-6-0) show <sup>a</sup> *Recommended R<sup>S</sup> vs Capacitive Load* curve ([Figure](#page-11-0) 33) to help the designer pick <sup>a</sup> value to give <sup>&</sup>lt; 0.5dB peaking to the load. The resulting frequency response curves show <sup>a</sup> 0.5dB peaked response for several selected capacitive loads and recommended  $R<sub>S</sub>$  combinations.

Parasitic capacitive loads greater than 2pF can begin taken from the Typical [Characteristics](#page-6-0) and  $P_{\text{O}}$  is the two degrade the performance of the OPA3695. Long power level in dBm at the 50 $\Omega$  load for one of the two to degrade the performance of the OPA3695. Long power level in dBm at the 50Ω load for one of the two<br>PCB traces, unmatched cables, and connections to closely-spaced test frequencies. For instance, at PCB traces, unmatched cables, and connections to other amplifier inputs can easily exceed this value. 40MHz, the OPA3695 at <sup>a</sup> gain of +8V/V has an Always consider this effect carefully and add the intercept of 35dBm at <sup>a</sup> matched <sup>50</sup>Ω load. If the full recommended series resistor as close as possible to envelope of the two frequencies must be  $2V_{PP}$  at this the OPA3695 output pin (see the *Board [Layout](#page-20-0)* load, this requires each tone to be 4dBm (1V<sub>PP</sub>). The *[Guidelines](#page-20-0)* section). Third-order intermodulation spurious tones is then 2 x

The criterion for setting this  $R_S$  resistor is a maximum  $(-79dBr)$ . bandwidth, flat frequency response at the load (< 0.5dB peaking). For the OPA3695 operating at <sup>a</sup> gain of +2V/V, the frequency response at the output pin is flat to begin with, allowing relatively small values of  $R<sub>S</sub>$  to be used for low capacitive loads.

### **DISTORTION PERFORMANCE**

The OPA3695 provides good distortion performance into <sup>a</sup> 100Ω load on ±5V supplies. Relative to alternative solutions, the OPA3695 holds much lower distortion at higher frequencies (> 20MHz) than alternative solutions. Generally, until the fundamental signal reaches very high-frequency or power levels, the second harmonic dominates the distortion with a

The OPA3695 has very low third-order harmonic distortion—especially with high gains. This feature also produces <sup>a</sup> high two-tone, third-order intermodulation intercept. Two graphs for this intercept are given in the in the Typical Characteristics; one for ±5V and one for +5V. The curves shown in each graph is defined at the  $50\Omega$ load when driven through <sup>a</sup> 50Ω matching resistor, to allow direct comparisons to RF MMIC devices.

the two test frequencies ( $f_1$  and  $f_2$ ) are specified in terms of average and delta frequency,  $f_{\rm O}$  = (f<sub>1</sub> + f<sub>2</sub>)/2 and Δf =  $|f_2 - f_1|/2$ , then the two, 3rd-order, close-in spurious tones appear at  $f_0 \pm 3 \times \Delta f$ . The difference between two equal test tone power levels and these intermodulation spurious power levels is given by  $\Delta$ dBc = 2 × (IM<sub>3</sub> – P<sub>0</sub>), where IM<sub>3</sub> is the intercept  $(35 - 4) = 62$ dBc below the test tone power level

![](_page_18_Picture_1.jpeg)

The OPA3695 offers an excellent balance between A current-feedback op amp such as the OPA3695 voltage and current noise terms to achieve <sup>a</sup> low provides exceptional bandwidth and slew rate, giving output noise under a variety of operating conditions. Fast pulse settling but only moderate dc accuracy.<br>The input noise voltage  $(1.8n\sqrt{Hz})$  is very low for a The Electrical Characteristics show an input offset The input noise voltage (1.8nV/ $\sqrt{Hz}$ ) is very low for a unity-gain stable amplifier. This low input voltage voltage comparable to high-speed voltage-feedback noise was achieved at the price\_\_of higher amplifiers. However, the two input bias currents are noninverting input current noise (18pA/ $\sqrt{Hz}$ ). As long somewhat higher and are unmatched. Whereas bias as the ac source impedance looking out of the current cancellation techniques are very effective with noninverting input is less than 100Ω, this current most voltage-feedback op amps, they do not noise does not contribute significantly to the total generally reduce the output dc offset for wideband output noise. The op amp input voltage noise and the current-feedback op amps. Because the two input two input current noise terms combine to give low bias currents are unrelated in both magnitude and output noise using the OPA3695. Figure 43 shows polarity, matching the source impedance looking out output noise using the OPA3695. Figure  $43$  shows the op amp noise analysis model with all of the noise of each input to reduce the error contributions to the terms included. In this model, all noise terms are output is ineffective. Evaluating the configuration of taken to be noise voltage or current density terms in  $\frac{1}{2}$  Figure 35 using a gain of +2V/V, using worst-case taken to be noise voltage or current density terms in either nV/ $\sqrt{Hz}$  or pA/ $\sqrt{Hz}$ .  $\sqrt{4z}$  is the two input offset voltage, and the two input bias

![](_page_18_Figure_5.jpeg)

**Figure 43. Op Amp Noise Model**

The total output spot noise voltage can be computed The OPA3695 provides an optional disable feature as the square root of the sum of all squared output that can be used to reduce system power. If the  $\sqrt{2}$ as the square root of the sum of all squared output that can be used to reduce system power. If the  $V_{\overline{DIS}}$  noise voltage contributors. Equation 1 shows the control pin is left unconnected, the OPA3695 noise voltage contributors. Equation 1 shows the control pin is left unconnected, the OPA3695 neeral form for the output noise voltage using the operates normally. This shutdown is intended only as general form for the output noise voltage using the operates normally. This shutdown is intended only as<br>a power-savings feature. Forward path isolation when

$$
E_{O} = \sqrt{\left(E_{Ni}^{2} + (I_{BN}R_{S})^{2} + 4kTR_{S}\right)NG^{2} + (I_{Bi}R_{F})^{2} + 4kTR_{F}NG}
$$
\n(1)

Dividing this expression through by noise gain (NG = noninverting node. Failure to properly account for this  $1 + R_F/R_G$ ) gives the equivalent input-referred spot voltage may cause undesirable responses in the noise voltage at the noninverting input, as shown in output signal when multiplexed. Configuring the noninverting input, as shown in a paralitier for high gains helps minimize this impact.

$$
E_{N} = \sqrt{E_{N1}^{2} + (I_{BN}R_{S})^{2} + 4kTR_{S} + \left(\frac{I_{BI}R_{F}}{NG}\right)^{2} + \frac{4kTR_{F}}{NG}}
$$
\n(2)

### **NOISE PERFORMANCE DC ACCURACY AND OFFSET CONTROL**

currents, gives <sup>a</sup> worst-case output offset range equal to:

$$
V_{OS} = \pm (NG \times V_{OS}) \pm (I_{BN} \times R_S/2 \times NG) \pm (I_{BI} \times R_F)
$$
  
=  $\pm (2 \times 3.5 \text{mV}) \pm (30 \mu A \times 25 \Omega \times 2) \pm (60 \mu A \times 604 \Omega)$   
=  $\pm 7 \text{mV} \pm 1.5 \text{mV} \pm 36.2 \text{mV}$   
=  $\pm 44.7 \text{mV}$ 

where  $NG =$  noninverting signal gain.

Minimizing the resistance seen by the noninverting input also minimizes the output dc error. For improved dc precision in <sup>a</sup> wideband low-gain amplifier, consider the [OPA842](http://focus.ti.com/docs/prod/folders/print/opa842.html) where <sup>a</sup> bipolar input is acceptable (low source resistance) or the [OPA656](http://focus.ti.com/docs/prod/folders/print/opa656.html) where <sup>a</sup> JFET input is required.

### **DISABLE OPERATION**

a power-savings feature. Forward path isolation when disabled is very good for small signals when configured for low gains. However, large-signal isolation is not ensured because of the ±1.2V limitation between the inverting node and the voltage may cause undesirable responses in the amplifier for high gains helps minimize this impact, but it is not ensured; proper analysis should be done by the designer.

![](_page_19_Picture_1.jpeg)

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Turn-on time is very quick from the shutdown condition (typically <sup>&</sup>lt; 25ns). Turn-off time strongly depends on the selected gain configuration and load, but is typically 1 $\mu$ s for the circuit of [Figure](#page-12-0) 35. To shut down, the control pin must be asserted low. This logic control is referenced to the positive supply, as the simplified circuit of Figure 44 shows.

![](_page_19_Figure_5.jpeg)

In normal operation, base current to  $Q1$  is provided As a worst-case example, compute the maximum  $T<sub>J</sub>$ through the 110kΩ resistor while the emitter current using an OPA3695IDBQ (SSOP-16 package) in the through the 15k $\Omega$  resistor sets up a voltage drop that circuit of [Figure](#page-12-0) 35 operating at the maximum is inadequate to turn on the two diodes in the  $Q1$  specified ambient temperature of  $+85^{\circ}$ C and driving a emitter. As V<sub>DIS</sub> is pulled low, additional current is grounded 100Ω load at V<sub>S</sub>/2. Maximum internal pulled through the 15k $\Omega$  resistor, eventually turning power is: on these two diodes ( $\approx$  80 $\mu$ A). At this point, any further current pulled out of  $V_{\overline{DIS}}$  goes through those diodes, holding the emitter-base voltage of Q1 at approximately 0V. This sequence shuts off the collector current out of Q1, turning the amplifier off. The supply current in the shutdown mode is only that required to operate the circuit of Figure 44.

The shutdown feature for the OPA3695 is <sup>a</sup> signals vary, along with the fact that part of the positive-supply-referenced, current-controlled quiescent current is steered to the output, thus interface. Open-collector (or drain) interfaces are reducing the  $10V \times 42.6$ mA dominant term. Compute most effective, as long as the controlling logic can the actual output stage power to get an accurate sustain the resulting voltage (in the open mode) that estimate of maximum junction temperature, or use appears at the  $V_{\overline{DIS}}$  pin. That voltage is one diode the results shown here as an absolute worst case below the positive supply voltage applied to the maximum scenario. OPA3695. For voltage output logic interfaces, the on/off voltage levels described in the [Electrical](#page-2-0) [Characteristics](#page-2-0) apply only for <sup>a</sup> +5V positive supply on the OPA3695. An open-drain interface is recommended for shutdown operation using <sup>a</sup> higher positive supply for the OPA3695 and/or logic families with inadequate high-level voltage swings.

### **THERMAL ANALYSIS**

The OPA3695 does not require heatsinking or airflow in most applications. Maximum desired junction temperature sets the maximum allowed internal power dissipation as described here. In no case should the maximum junction temperature be allowed to exceed +150°C.

Operating junction temperature  $(T_J)$  is given by  $T_A$  +  $P_D \times \theta_{JA}$ . The total internal power dissipation (P<sub>D</sub>) is the sum of quiescent power  $(P_{DQ})$  and additional power dissipated in the output stage  $(P_{DL})$  to deliver load power. Quiescent power is simply the specified no-load supply current times the total supply voltage across the part.  $P_{DL}$  depends on the required output signal and load but would, for <sup>a</sup> grounded resistive load, be at <sup>a</sup> maximum when the output is fixed at <sup>a</sup> voltage equal to 1/2 either supply voltage (for equal bipolar supplies). Under this worst-case condition,  $P_{DL}$  =  $V_S^2/(4 \times R_L)$  where  $R_L$  includes feedback network loading. This value is the absolute highest power that can be dissipated for a given  $R_L$ . All actual applications dissipate less power in the output stage.

Note that it is the power in the output stage and not **Figure 44. Simplified Disable Control Circuit** into the load that determines internal power dissipation.

 $P_D = 10V \times 42.6 \text{ mA} + 3 \times 5^2/(4 \times (100 \Omega || 1.2 \text{k}\Omega)) = 629 \text{ mW}$ 

Maximum T<sub>J</sub> =  $+85^{\circ}$ C + (0.629W × 80 $^{\circ}$ C/W) = 135 $^{\circ}$ C

Actual applications operate at <sup>a</sup> lower junction temperature than the +135°C computed above. This condition is because the RMS voltage of the output estimate of maximum junction temperature, or use

<span id="page-20-0"></span>![](_page_20_Picture_1.jpeg)

### **BOARD LAYOUT GUIDELINES**

Achieving optimum performance with <sup>a</sup> high-frequency amplifier such as the OPA3695 requires careful attention to PCB layout parasitics and external component types. Recommendations that optimize OPA3695 performance include:

**a) Minimize parasitic capacitance** to any ac ground greater than 2.0kΩ, this parasitic capacitance can affect an<br>for all of the signal I/O pins. Parasitic capacitance on add a pole and/or zero below 400MHz that can affec for all of the signal I/O pins. Parasitic capacitance on add a pole and/or zero below 400MHz that can affect the output can cause instability; on the noninverting circuit operation. Keep resistor values as low as the output can cause instability; on the noninverting circuit operation. Keep resistor values as low as low as<br>input, it can react with the source impedance to possible consistent with load driving considerations. input, it can react with the source impedance to cause unintentional bandlimiting. To reduce unwanted capacitance, create <sup>a</sup> window around the signal I/O pins in all of the ground and power planes around those pins. Otherwise, ground and power planes should be unbroken elsewhere on the board.

**b) Minimize the distance** (< 0.25" or 6,35mm) from (50mils to 100mils, or 1,27mm to 2,54mm) should be the power-supply pins to high-frequency  $0.1\mu$ F used, preferably with ground and power planes decoupling capacitive device pins, the ground opened up around them. Estimate the total capacitive decoupling capacitors. At the device pins, the ground opened up around them. Estimate the total capacitive and power-plane layout should not be in close load and set  $R_S$  from the plot of *Recommended*  $R_S$  vs and power-plane layout should not be in close load and set R<sub>S</sub> from the plot of *Recommended R<sub>S</sub> vs* proximity to the signal I/O pins. Avoid narrow power Capacitive Load (Figure 33). Low parasitic capacitive proximity to the signal I/O pins. Avoid narrow power *Capacitive Load* ([Figure](#page-11-0) 33). Low parasitic capacitive and ground traces to minimize inductance between loads  $(< 4pF)$  may not need an  $R<sub>S</sub>$  because the the decoupling capacitors. The  $\overline{O}$  OPA3695 is nominally compensated to operate with a the pins and the decoupling capacitors. The power-supply connections should always be 2pF parasitic load. If a long trace is required, and the decoupled with these capacitors. Larger (2.2uF to 6dB signal loss intrinsic to a doubly-terminated decoupled with these capacitors. Larger (2.2µF to 6dB signal loss intrinsic to a doubly-terminated<br>6.8µF) decoupling capacitors, effective at lower transmission line is acceptable, implement a matched 6.8µF) decoupling capacitors, effective at lower transmission line is acceptable, implement <sup>a</sup> matched frequency, should also be used on the supply pins. impedance transmission line using microstrip or These capacitors may be placed somewhat farther stripline techniques (consult an ECL design handbook from the device and may be shared among several for microstrip and stripline layout techniques). A 50 $\Omega$ from the device and may be shared among several devices in the same area of the PCB.

**c) Careful selection and placement of external components preserve the high-frequency performance of the OPA3695.** Use resistors that have low reactance at high frequencies. Surface-mount resistors work best and allow <sup>a</sup> tighter overall layout. Metal film and carbon composition axially-leaded resistors can also provide good high-frequency performance. Again, keep the leads and PCB trace length as short as possible. Never use wirewound type resistors in a high-frequency application. The output pin and inverting input pin are the most sensitive to parasitic capacitance; therefore, always position the series output resistor, if any, as close as possible to the output pin. Other network components, such as noninverting input termination resistors, should also be placed close to the package. Where double-side component mounting is allowed, place the feedback resistor directly under the package on the other side of the board between the output and inverting input pins. The frequency response is primarily determined by the feedback resistor value, as described previously. Increasing its value reduces the bandwidth, while decreasing it gives <sup>a</sup> more peaked frequency response. The 604Ω feedback resistor (used in the typical performance specifications at a gain of  $+2$ V/V on  $\pm 5$ V supplies) is <sup>a</sup> good starting point for design. Note that <sup>a</sup> 909Ω feedback resistor, rather than <sup>a</sup> direct short, is required for the unity-gain follower application. A current-feedback op amp requires <sup>a</sup> feedback resistor—even in the unity-gain follower configuration—to control stability. Good axial metal film or surface-mount resistors have approximately 0.2pF in shunt with the resistor. For resistor values

**d) Connections to other wideband devices** on the PCB may be made with short direct traces or through onboard transmission lines. For short connections, consider the trace and the input to the next device as <sup>a</sup> lumped capacitive load. Relatively wide traces environment is normally not necessary on board, and in fact, <sup>a</sup> higher impedance environment improves distortion, as shown in the distortion versus load plots. With <sup>a</sup> characteristic board trace impedance defined based on board material and trace dimensions, <sup>a</sup> matching series resistor into the trace from the output of the OPA3695 is used, as well as <sup>a</sup> terminating shunt resistor at the input of the destination device. Remember also that the terminating impedance is the parallel combination of the shunt resistor and the input impedance of the destination device; this total effective impedance should be set to match the trace impedance. If the 6dB attenuation of <sup>a</sup> doubly-terminated transmission line is unacceptable, <sup>a</sup> long trace can be series-terminated at the source end only. Treat the trace as <sup>a</sup> capacitive load in this case and set the series resistor value as illustrated in the plot of [Figure](#page-11-0) 33. This configuration does not preserve signal integrity as well as <sup>a</sup> doubly-terminated line. If the input impedance of the destination device is low, there will be some signal attenuation as <sup>a</sup> result of the voltage divider formed by the series output into the terminating impedance.

**e) Socketing <sup>a</sup> high-speed part such as the OPA3695 is not recommended.** The additional lead length and pin-to-pin capacitance introduced by the socket can create an extremely troublesome parasitic network, which can make it almost impossible to achieve <sup>a</sup> smooth, stable frequency response. Best results are obtained by soldering the OPA3695 directly onto the board.

### **INPUT AND ESD PROTECTION**

The OPA3695 is built using <sup>a</sup> very high-speed complementary bipolar process. The internal junction breakdown voltages are relatively low for these very small geometry devices. These breakdowns are reflected in the Absolute [Maximum](#page-1-0) Ratings table. All device pins are protected with internal ESD protection diodes to the power supplies, as shown in Figure 45.

![](_page_21_Picture_5.jpeg)

Texas

![](_page_21_Figure_6.jpeg)

**Figure 45. Internal ESD Protection**

These diodes provide moderate protection to input overdrive voltages above the supplies as well. The protection diodes can typically support 30mA continuous current. Where higher currents are possible (for example, in systems with ±15V supply parts driving into the OPA3695), current limiting series resistors may be added on the noninverting input. Keep this resistor value as low as possible; high values degrade both noise performance and frequency response.

![](_page_22_Picture_0.jpeg)

<span id="page-22-0"></span>Texas **INSTRUMENTS** 

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### **EVALUATION MODULE**

To evaluate the OPA3695, an evaluation module (EVM) is available. This EVM allows for testing the OPA3695 in many different systems. Inputs and outputs include SMA connectors commonly found in high-frequency systems along with  $50\Omega$  characteristic impedance traces. Because the traces are very short, This EVM is designed to be primarily used with split changing the input and output terminations resistors supplies from  $\pm 2.5V$  up to  $\pm 6V$ . This EVM can be changing the input and output terminations resistors from 49.9Ω to 75Ω has essentially no impact when used with a 5V single-supply up to 12V, but care evaluating video signals. Several unpopulated must be taken to account for the input termination evaluating video signals. Several unpopulated component pads are found on the EVM to allow for resistor connections to ground. Adiitionally, the 100uF different input and output configurations as dictated bypass capcitors C1 and C2 are rate at 10V. If single by the user. Supply is used with more than 10V applied, these by the user.

By default, all channels of the EVM are configured for <sup>a</sup> noninverting gain of +2V/V. If inverting configuration or differential input configuration is desired, then simply replacing R1, R4, and R7 with desired resistors allows these configurations to be set up quite easily. Also, the feedback and gain resistors can be easily replaced to allow for any gain desired.

Note that even though the default gain of the recommended even if the final use is single-supply.<br>OPA3695 is +2V/V, or 6dB, the output 49.90 source Example: if the final usage is to be 12V single-supply, OPA3695 is +2V/V, or 6dB, the output 49.9Ω source Example: if the final usage is to be 12V single-supply, termination resistors (R13, R14, and R15) and the user-applied 50Ω end-termination resistance voltage to mid-rail—or an equivalent 6V for a<br>commonly found in test systems makes the overall single-supply configuration. commonly found in test systems makes the overall system gain appear as 0dB.

Each channel's disable control is independently [Figure](#page-27-0) 47 to Figure 50 illustrate the four layers of the configured. By default, the use of iumpers JP1, JP2. EVM PCB, incorporating standard high-speed layout configured. By default, the use of jumpers JP1, JP2, EVM PCB, incorporating standard high-speed layout and easy method to practices. Table 3 lists the Bill of Materials for the and JP3 allows for a quick and easy method to practices. [Table](#page-28-0) 3 lists the Bill of Mater<br>evaluate the disable function of the OPA3695. EVM as supplied from Texas Instruments. evaluate the disable function of the OPA3695. However, if this control must be externally controlled, then using the SMA connectors J10, J11, and J12 is recommended. The termination resistors R19, R20, and R21 should to be changed to match the source

impedance, but it is not required. Attention to the voltage appearing at each disable pin is required to ensure proper operation of this feature. The voltage at the disable pin is shown in the [Electrical](#page-2-0) [Characteristics](#page-2-0) section of this data sheet.

capacitors should be changed to accomodate the increased supply voltage. The OPA3695 allowable input range is defined in the Electrical [Characteristics](#page-2-0) section of this datasheet and must be adhered to for proper operation. Also note that the gain setting resistors are also connected to ground. Thus, any dc offset is increased proportionally by the gain. As such, using the EVM as a split supply is recommended even if the final use is single-supply.

[Figure](#page-23-0) 46 shows the OPA3695EVM schematic.

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<span id="page-23-0"></span>SBOS355A–APRIL 2008–REVISED SEPTEMBER 2008 ... **www.ti.com**

![](_page_23_Figure_3.jpeg)

**Figure 46. OPA3695D EVM Schematic**

![](_page_24_Picture_0.jpeg)

<span id="page-24-0"></span>![](_page_24_Picture_1.jpeg)

![](_page_24_Figure_4.jpeg)

**Figure 47. OPA3695D EVM PCB: Top Layer**

![](_page_25_Picture_4.jpeg)

**Figure 48. OPA3695D EVM PCB: Layer 2**

![](_page_25_Picture_6.jpeg)

![](_page_26_Picture_0.jpeg)

![](_page_26_Picture_1.jpeg)

![](_page_26_Picture_4.jpeg)

**Figure 49. OPA3695D EVM PCB: Layer 3**

![](_page_27_Picture_2.jpeg)

<span id="page-27-0"></span>![](_page_27_Figure_4.jpeg)

**Figure 50. OPA3695D EVM PCB: Bottom Layer**

<span id="page-28-0"></span>![](_page_28_Picture_0.jpeg)

### **OPA3695EVM Bill of Materials**

![](_page_28_Picture_620.jpeg)

### **Table 3. OPA3695D EVM**

### **Revision History**

![](_page_29_Picture_146.jpeg)

![](_page_30_Picture_0.jpeg)

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### **EVM WARNINGS AND RESTRICTIONS**

It is important to operate this EVM within the input voltage range of ±1.7V to ±6.5V dual supply and the output voltage range of 0V to ±6.5V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact <sup>a</sup> TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact <sup>a</sup> TI field representative.

During normal operation, some circuit components may have case temperatures greater than +85°C. The EVM is designed to operate properly with certain components above +85°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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### **PACKAGING INFORMATION**

![](_page_31_Picture_292.jpeg)

**(1)** The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

**(2)** Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

**(3)** MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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### **TAPE AND REEL INFORMATION**

![](_page_32_Figure_4.jpeg)

![](_page_32_Figure_5.jpeg)

### **QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**

![](_page_32_Figure_7.jpeg)

![](_page_32_Picture_166.jpeg)

![](_page_32_Picture_167.jpeg)

![](_page_33_Picture_0.jpeg)

# **PACKAGE MATERIALS INFORMATION**

![](_page_33_Figure_3.jpeg)

\*All dimensions are nominal

![](_page_33_Picture_58.jpeg)

DBQ (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE

![](_page_34_Figure_3.jpeg)

NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15) per side.

D. Falls within JEDEC MO-137 variation AB.

![](_page_34_Picture_8.jpeg)

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![](_page_35_Picture_1568.jpeg)

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